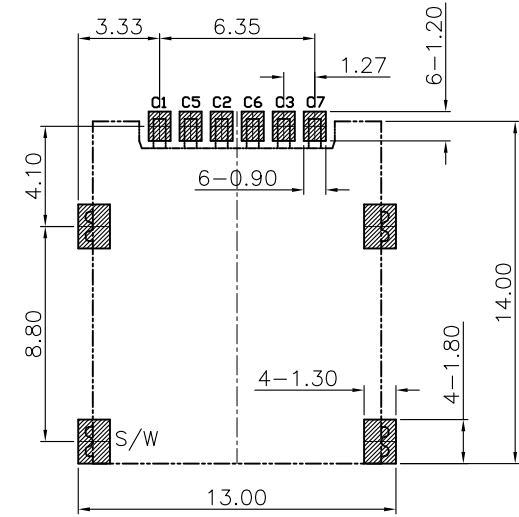
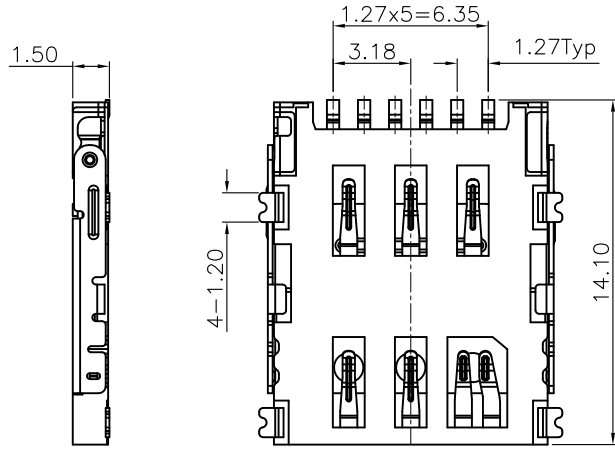
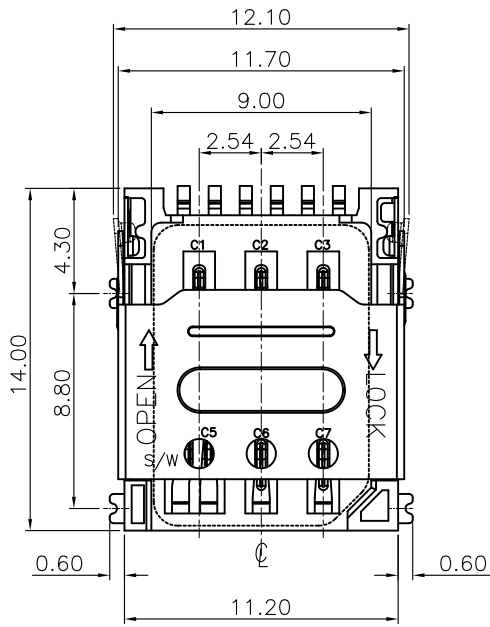
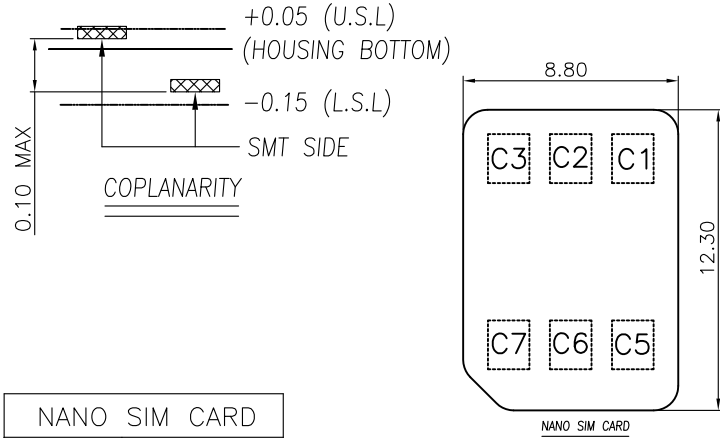
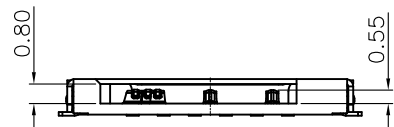


Rev No.	Description of Revision	Date	Name	Approved	ECN No.

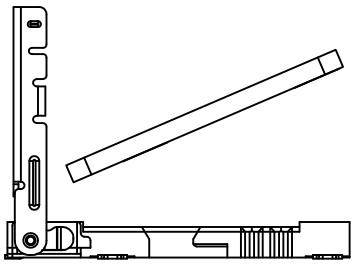


RECOMMENDED PCB LAYOUT  
 GENERAL TOLERANCE ±0.05  
 SMT SOLDER AREA

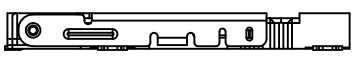


NOTES:

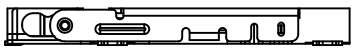
- ELECTRICAL CHARACTERISTICS
  - CONTACT RESISTANCE: 60 Milliohms Max
  - INSULATION RESISTANCE: 1,000 Megohms Min.
  - VOLTAGE RATING: 50V.
  - CURRENT RATING: 1.0A.
- MECHANICAL CHARACTERISTICS
  - OPERATION TEMPERATURE RANGE: -20°C~+85°C
  - DURABILITY: 5000 CYCLES
- MATERIAL:
  - HOUSING: THERMOPLASTIC, UL 94-V0
  - TERMINAL: PHOSPHOR BRONZE, T=0.15
  - SHELL: STAINLESS STEEL, T=0.20
- FINISHED:
  - TERMINAL: Ni PLATED UNDER, 3U" Au MIN PLATED ON CONTACT AREA, AU PLATED ON SOLDER TAIL



STEP 1 INSERT Micro-SIM CARD

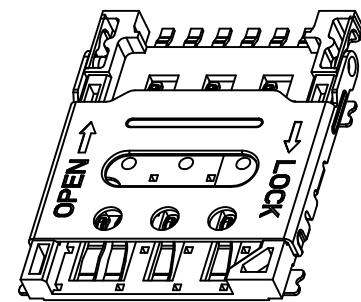


STEP 2 PUSH THE SHELL



STEP 3 FINISH

NANO SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	Switch Pin



UNLESS OTHERWISE SPECIFIED TOLERANCES					
DECIMALS:		ANGLES		TITLE: 翻盖式 NanoSIM卡 卡座 6+1	
X.	±0.20	X°.	±2°	Drawn.	PART NO. ZX-NSIM-281.4J-F
X.X	±0.15	X.X°	±1°	Checked.	SCALE: 3:10 UNIT: mm PROJ.
X.XX	±0.10	X.XX°	±0.5°	Approved.	SIZE: A4 SHEET: 1 OF 1 REV. A
X.XXX	±0.05	CUSTOMER COPY			